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Intelligent Power Module (IPM) 600 V, 10 A



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Overview

This "Inverter IPM" is highly integrated device containing all High Voltage (HV) control from HV-DC to 3-phase outputs in a single SIP module (Single-In line Package). Output stage uses IGBT/FRD technology and implements Under Voltage Protection (UVP) and Over Current Protection (OCP) with a Fault Detection output flag. Internal Boost diodes are provided for high side gate boost drive.

Function

- Single control power supply due to Internal bootstrap circuit for high side pre-driver circuit
- All control input and status output are at low voltage levels directly compatible with microcontrollers
- Built-in cross conduction prevention
- Externally accessible embedded thermistor for substrate temperature measurement

Certification

• UL1557 (File Number : E339285)

Specifications

Absolute Maximum Ratings at Tc = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Supply voltage	V _{CC}	P to N, surge < 500 V *1	450	V
Collector-emitter voltage	V _{CE}	P to U, V, W or U, V, W to N	600	V
Output ourseat		P, N, U, V, W terminal current	±10	А
Output current	lo	P, N, U, V, W terminal current at Tc = 100°C	±5	Α
Output peak current	Іор	P, N, U, V, W terminal current for a Pulse width of 1 ms.	±20	А
Pre-driver voltage	VD1, 2, 3, 4	VB1 to U, VB2 to V, VB3 to W, V _{DD} to V _{SS} $*2$	20	V
Input signal voltage	VIN	HIN1, 2, 3, LIN1, 2, 3	-0.3 to 7	V
FLTEN terminal voltage	VFLTEN	FLTEN terminal	-0.3 to V _{DD}	V
Maximum power dissipation	Pd	IGBT per channel	22	W
Junction temperature	Tj	IGBT, FRD	150	°C
Storage temperature	Tstg		-40 to +125	°C
Operating substrate temperature	Тс	IPM case temperature	-40 to +100	°C
Tightening torque		Case mounting screws *3	0.9	Nm
Isolation voltage	Vis	50 Hz sine wave AC 1 minute *4	2000	VRMS

Reference voltage is "VSS" terminal voltage unless otherwise specified.

*1 : Surge voltage developed by the switching operation due to the wiring inductance between "P" and "N" terminal.

*2 : Terminal voltage: VD1 = VB1 to U, VD2 = VB2 to V, VD3 = VB3 to W, VD4 = V_{DD} to V_{SS}

- *3 : Flatness of the heat-sink should be 0.15 mm and below.
- *4 : Test conditions : AC 2500 V, 1 s.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ORDERING INFORMATION

See detailed ordering and shipping information on page 14 of this data sheet.

Electrical Characteristics at Tc = 25°C, VD1, VD2, VD3, VD4 = 15 V

Parameter	Symbol	Conditions		Test circuit	min	typ	max	Unit
Power output section								
Collector-emitter cut-off current	ICE	V _{CE} = 600 V		- : 4	-	-	0.1	mA
Bootstrap diode reverse current	IR(BD)	VR(BD)		Fig.1	-	-	0.1	mA
		lc = 10 A	Upper side		-	1.4	2.3	
Collector to emitter saturation voltage		Tj = 25°C	Lower side *1	- 0	-	1.7	2.6	
	V _{CE} (sat)	lc = 5 A	Upper side	Fig.2	-	1.3	-	V
		Tj = 100°C	Lower side *1		-	1.6	-	
		IF = 10 A	Upper side		-	1.3	2.2	
		Tj = 25°C	Lower side *1		-	1.6	2.5	
Diode forward voltage	VF	IF = 5 A	Upper side	Fig.3	-	1.2	-	V
		Tj = 100°C	Lower side *1	1	-	1.5	_	1
Junction to case	θj-c(T)	IGBT	•		-	-	5.5	
thermal resistance	θj-c(D)	FRD			-	-	6.5	°C/W
Control (Pre-driver) section	•	•				•		
Pre-driver current consumption		VD1, 2, 3 = 15 V		_	-	0.08	0.4	
	ID	VD4 = 15 V	Fig.4	-	1.6	4.0	mA	
High level Input voltage	Vin H				2.5	-	-	V
Low level Input voltage	Vin L	HIN1, HIN2, H			-	-	0.8	V
Input threshold voltage hysteresis *1	Vinth(hys)	LIN1, LIN2, LI	N3 to V _{SS}		0.5	0.8	_	V
Logic 0 input leakage current	I _{IN+}	VIN = +3.3 V			76	118	160	μA
Logic 1 input leakage current	I _{IN-}	VIN = 0 V			97	150	203	μA
FLTEN terminal input electric current	loSD	FAULT : ON/V	/FLTEN = 0.1 V		_	2	_	mA
FAULT clearance delay time	FLTCLR	Fault output la	tch time		6	9	12	ms
	V _{EN+}	Enable			2.5	-	_	V
FLTEN Threshold	V _{EN-}	Disable			-	-	0.8	
V _{CC} and V _S undervoltage upper threshold	V _{CCUV+} V _{SUV+}				10.5	11.1	11.7	V
V _{CC} and V _S undervoltage lower threshold	VCCUV- VSUV-				10.3	10.9	11.5	V
V_{CC} and V_S undervoltage hysteresis	V _{CCUVH} V _{SUVH-}				0.14	0.2	_	А
Over current protection level	ISD	PW = 100 μs		Fig.5	10	-	17	А
Output level for current monitor	ISO	lo = 10 A			0.30	0.33	0.36	V

Reference voltage is "VSS" terminal voltage unless otherwise specified.

*1 : The lower side's $V_{\mbox{CE}}(\mbox{sat})$ and VF include a loss by the shunt resistance

Electrical Characteristics at Tc = 25° C, VD1, VD2, VD3, VD4 = 15 V, V_{CC} = 300 V, L = 3.9 mH

Parameter	Symbol	Symbol Conditions		min	typ	max	Unit
Switching Character	•	·			•		
	tON	lo = 10 A	Fig. C	0.2	0.4	1.1	_
Switching time	tOFF	Inductive load	Fig.6	-	0.5	1.2	μS
Turn-on switching loss	Eon	Ic = 5 A, P = 300 V,		-	200	-	μJ
Turn-off switching loss	Eoff	V _{DD} = 15 V, L = 3.9 mH	Fig.6	-	130	-	μJ
Total switching loss	Etot	Tc = 25°C		-	330	-	μJ
Turn-on switching loss	Eon	Ic = 5 A, P = 300 V,		-	240	-	μJ
Turn-off switching loss	Eoff	V _{DD} = 15 V, L = 3.9 mH	Fig.6	-	160	-	μJ
Total switching loss	Etot	Tc = 100°C		-	400	-	μJ
Diode reverse recovery energy	Erec	I _F = 5 A, P = 400 V, V _{DD} = 15 V,		-	17	-	μJ
Diode reverse recovery time	Trr	L = 0.5 mH, Tc = 100°C		-	62	-	ns
Reverse bias safe operating area	RBSOA	lo = 20 A, V _{CE} = 450 V			Full square		
Short circuit safe operating area	SCSOA	V _{CE} = 400 V, Tc = 100°C		4	-	-	μS

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Notes :

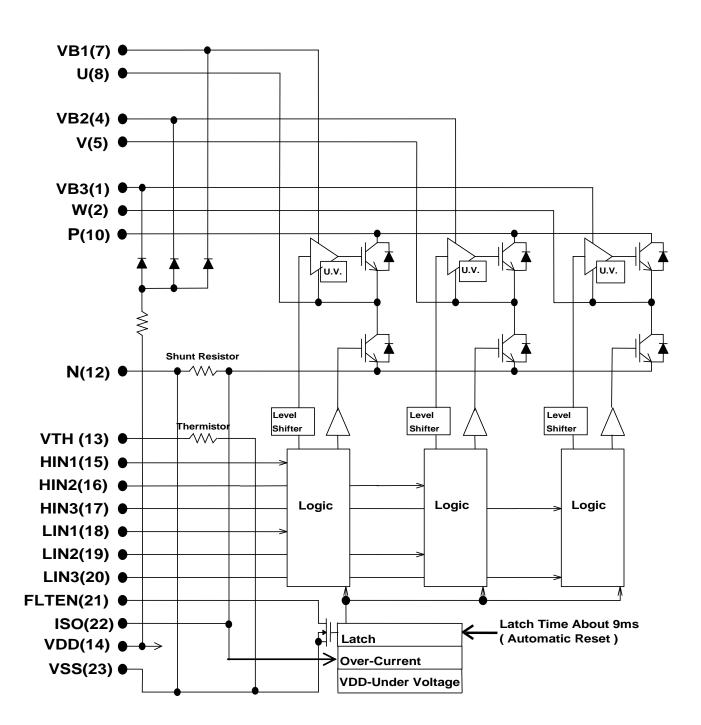
1. The pre-drive power supply low voltage protection has approximately 0.2 V of hysteresis and operates as follows.

Upper side : The gate is turned off and will return to regular operation when recovering to the normal voltage, but the latch will continue till the input signal will turn 'high'.

Lower side : The gate is turned off and will automatically reset when recovering to normal voltage. It does not depend on input signal voltage.

2. The pre-drive low voltage protection is the feature to protect devices when the pre-driver supply voltage falls due to an operating malfunction.

Equivalent Block Diagram



Module Pin-Out Description

Pin	Name	Description
1	VB3	High Side Floating Supply Voltage 3
2	W, VS3	Output 3 - High Side Floating Supply Offset Voltage
3	_	Witout Pin
4	VB2	High Side Floating Supply voltage 2
5	V,VS2	Output 2 - High Side Floating Supply Offset Voltage
6	_	Witout Pin
7	VB1	High Side Floating Supply voltage 1
8	U,VS1	Output 1 - High Side Floating Supply Offset Voltage
9	_	Witout Pin
10	Р	Positive Bus Input Voltage
11	_	Witout Pin
12	Ν	Negative Bus Input Voltage
13	VTH	Temperature Feedback
14	VDD	+15 V Main Supply
15	HIN1	Logic Input High Side Gate Driver - Phase U
16	HIN2	Logic Input High Side Gate Driver - Phase V
17	HIN3	Logic Input High Side Gate Driver - Phase W
18	LIN1	Logic Input Low Side Gate Driver - Phase U
19	LIN2	Logic Input Low Side Gate Driver - Phase V
20	LIN3	Logic Input Low Side Gate Driver - Phase W
21	FLTEN	Fault output and Enable
22	ISO	Current monitor output
23	VSS	Negative Main Supply

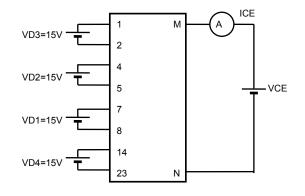
Test Circuit

The tested phase U+ shows the upper side of the U phase and U- shows the lower side of the U phase.

■ ICE / IR(BD)

	U+	V+	W+	U-	V-	W-
М	10	10	10	8	5	2
N	8	5	2	12	12	12

	U(BD)	V(BD)	W(BD)
М	7	4	1
N	23	23	23





■ V_{CE}(sat) (test by pulse)

	U+	V+	W+	U-	V-	W-
М	10	10	10	8	5	2
Ν	8	5	2	12	12	12
m	15	16	17	18	19	20

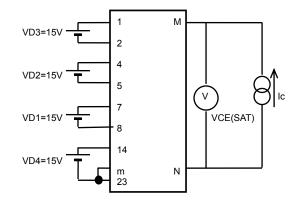


Fig.2

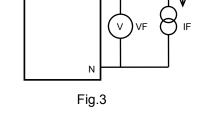
Μ

■ VF (test by pulse)

	U+	V+	W+	U-	V-	W-
М	10	10	10	8	5	2
Ν	8	5	2	12	12	12

∎ ID

	VD1	VD2	VD3	VD4
М	7	4	1	14
Ν	8	5	2	23



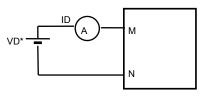


Fig.4

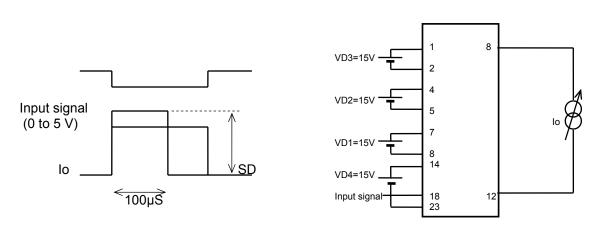
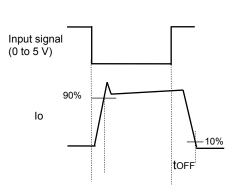
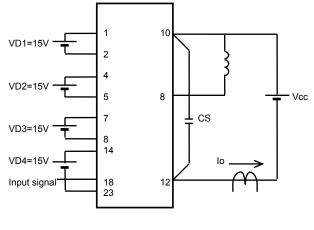


Fig.5

Switching time (The circuit is a representative example of the lower side U phase.)







6

Input / Output Timing Diagram

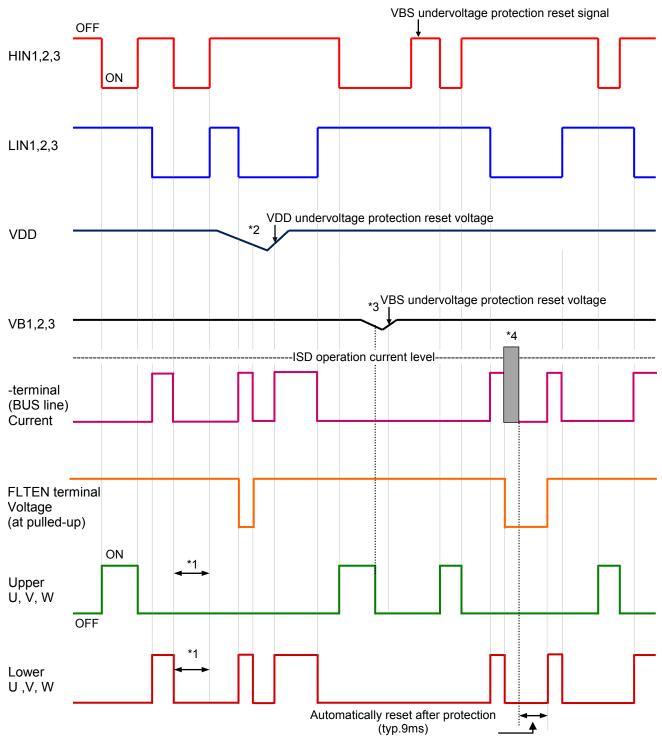


Fig.7

Notes

- *1 : Diagram shows the prevention of shoot-through via control logic. More dead time to account for switching delay needs to be added externally.
- *2 : When V_{DD} decreases all gate output signals will go low and cut off all of 6 IGBT outputs. When V_{DD} rises the operation will resume immediately.
- *3 : When the upper side gate voltage at VB1, VB2 and VB3 drops only, the corresponding upper side output is turned off. The outputs return to normal operation immediately after the upper side gate voltage rises.
- *4 : In case of over current detection, all IGBT's are turned off and the FAULT output is asserted. Normal operation resumes in 6 to 12ms after the over current condition is removed.

Logic level table

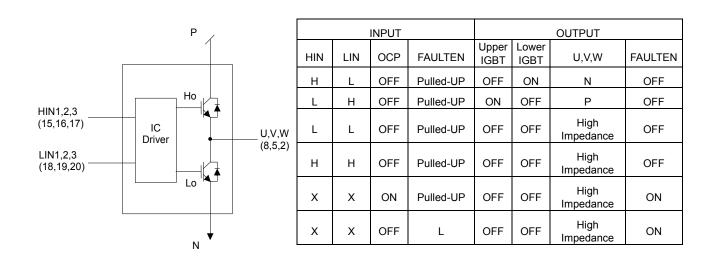
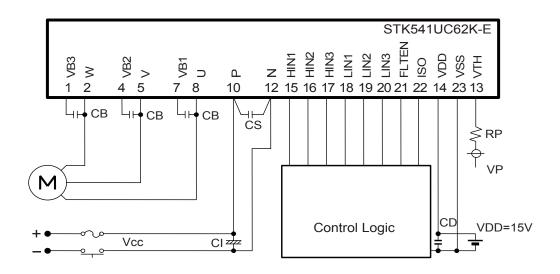


Fig. 8





Recommended Operating Conditions

Item	Symbol	Conditions	min	typ	max	Unit
Supply voltage	VCC	P to N	0	280	450	V
Des drives such that	VD1, 2, 3	VB1 to U, VB2 to V, VB3 to W	12.5	15	17.5	
Pre-driver supply voltage	VD4 VD5 to VSS		13.5	15	16.5	V
ON-state input voltage	VIN(ON)	HIN1, HIN2, HIN3,	0	-	0.3	v
OFF-state input voltage	VIN(OFF)	LIN1, LIN2, LIN3	3.0	-	5.0	v
PWM frequency	fPWM	_	1	-	20	kHz
Dead time	DT	Turn-off to turn-on	2	-	-	μs
Allowable input pulse width	PWIN	ON and OFF	1	-	-	μs
Tightening torque	_	'M3' type screw	0.6	-	0.9	Nm
*1 Pre-drive power supply (VD4	4 = 15 ±1.5 V) mi	ust have the capacity of Io = 20 mA (DC), 0	5 A (Peak).	•	•	•

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

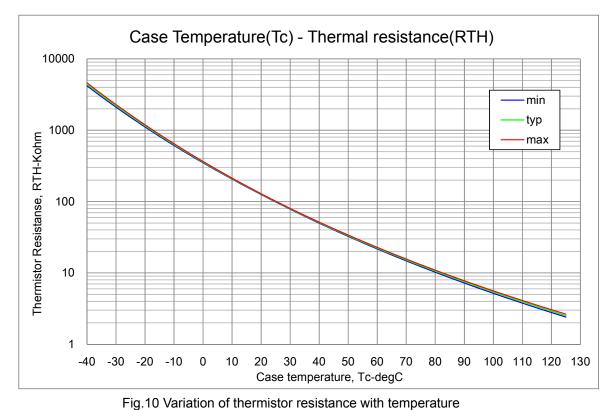
Usage Precaution

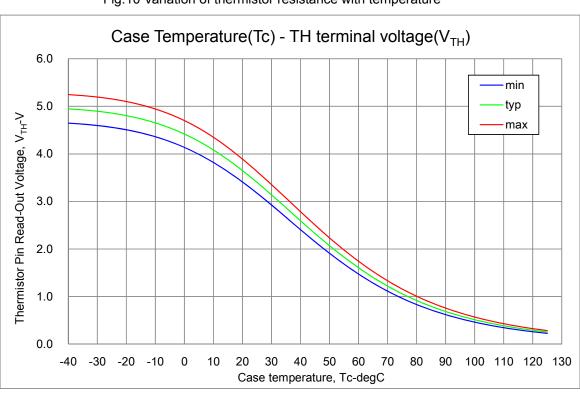
- 1. This IPM includes bootstrap diode and resistors. Therefore, by adding a capacitor "CB", a high side drive voltage is generated; each phase requires an individual bootstrap capacitor. The recommended value of CB is in the range of 1 to 47 μ F, however this value needs to be verified prior to production. If selecting the capacitance more than 47 μ F (±20%), connect a resistor (about 20 Ω) in series between each 3-phase upper side power supply terminals (VB1,2,3) and each bootstrap capacitor. When not using the bootstrap circuit, each upper side pre-drive power supply requires an external independent power supply.
- 2. It is essential that wirning length between terminals in the snubber circuit be kept as short as possible to reduce the effect of surge voltages. Recommended value of "CS" is in the range of 0.1 to 10 μ F.
- 3. "ISO" (pin22) is terminal for current monitor. When the pull-down resistor is used, please select it more than 5.6 k Ω
- 4. "FLTEN" (pin21) is open DRAIN output terminal (Active Low). Pull up resistor is recommended more than 5.6 kΩ.
- 5. Inside the IPM, a thermistor used as the temperature monitor for internal subatrate is connected between VSS terminal and VTH terminal, therefore, an external pull up resistor connected between the TH terminal and an external power supply should be used. The temperature monitor example application is as follows, please refer the Fig.10 and below.
- 6. The over-current protection feature is not intended to protect in exceptional fault condition. An external fuse is recommended for safety.
- When "N" and "V_{SS}" terminal are short-circuited on the outside, level that over-current protection (ISD) might be changed from designed value as IPM. Please check it in your set ("N" terminal and "V_{SS}" terminal are connected in IPM).
- 8. When input pulse width is less than 1.0 µs, an output may not react to the pulse. (Both ON signal and OFF signal)

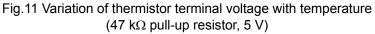
This data shows the example of the application circuit, does not guarantee a design as the mass production set.

The characteristic of thermistor

Parameter	Symbol	Condition	Min	Тур.	Max	Unit
Resistance	R ₂₅	Tc = 25°C	99	100	101	kΩ
Resistance	R ₁₀₀	Tc = 100°C	5.12	5.38	5.66	kΩ
B-Constant (25 to 50 °C)	В		4165	4250	4335	к
Temperature Range			-40	-	+125	С°







The characteristic of PWM switching frequency

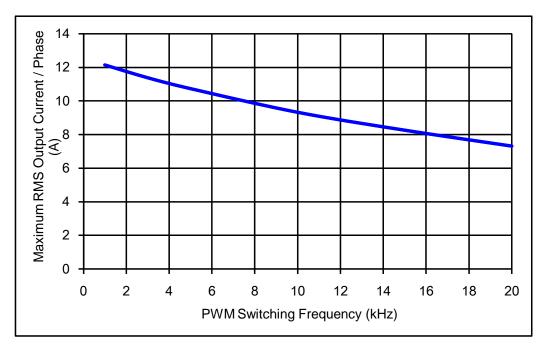


Fig. 12 Maximum sinusoidal phase current as function of switching frequency at Tc = 100°C, V_{CC} = 400 V

CB capacitor value calculation for bootstrap circuit

Calculate conditions

Parameter	Symbol	Value	Unit
Upper side power supply	VBS	15	V
Total gate charge of output power IGBT at 15 V	QG	89	nC
Upper limit power supply low voltage protection	UVLO	12	V
Upper side power dissipation	IDMAX	400	μA
ON time required for CB voltage to fall from 15 V to UVLO	TONMAX	-	s

Capacitance calculation formula Thus, the following formula are true VBS x CB - QG - IDMAX * TONMAX = UVLO * CB therefore,

CB = (QG + IDMAX * TONMAX) / (VBS - UVLO)

The relationship between TONMAX and CB becomes as follows. CB is recommended to be approximately 3 times the value calculated above. The recommended value of CB is in the range of 1 to 47 µF, however, this value needs to be verified prior to production.

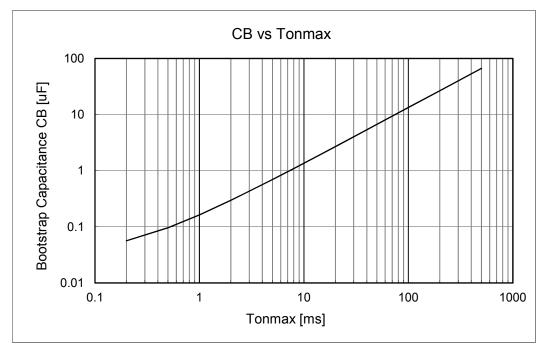
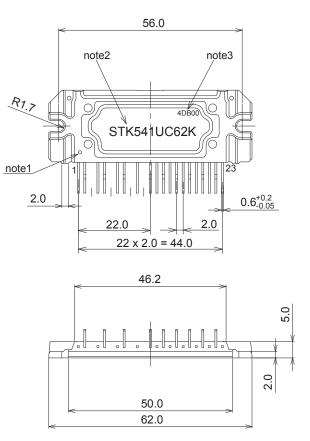


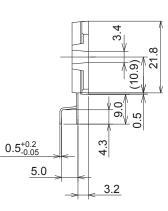
Fig. 15 Tonmax - CB characteristic

PACKAGE DIMENSIONS unit : mm

The tolerances of length are +/- 0.5 mm unless otherwise specified.



missing pin ; 3, 6, 9, 11



- note1 : Mark for No.1 pin identification.
- note2 : The form of a character in this drawing differs from that of IPM.
- note3 : This indicates the date code. The form of a character in this drawing differs from that of IPM.

ORDERING INFORMATION

Device	Package	Shipping (Qty / Packing)
STK541UC62K-E	SIP23 56x21.8 (Pb-Free)	8 / Tube

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